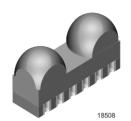


Fast Infrared Transceiver Module (MIR, 1.152 Mbit/s) for IrDA[®] applications

Description

The TFBS5711 is an infrared transceiver module compliant to the latest IrDA physical layer standard for fast infrared data communication, supporting IrDA speeds up to 1.152 Mbit/s (MIR), HP-SIR[®], Sharp ASK[®] and carrier based remote control modes up to 2 MHz. Integrated within the transceiver module are a PIN photodiode, an infrared emitter (IRED), and a low-power control IC to provide a total front-end solution in a single package.





The transceivers are capable of directly interfacing with a wide variety of I/O devices, which perform the modulation/ demodulation function. At a minimum a serial resistor for current control is the only external component required in implementing a complete solution. TFBS5711 has a tri-state output and is floating in shut-down mode with a weak pull-up.

Features

- Compliant to the latest IrDA physical layer low power specification (up to 1.152 Mbit/s) and TV Remote Control
- Operates from 2.7 V to 5.5 V within specification
- · Industries smallest footprint
 - 6.0 mm length
 - 1.9 mm height
- Low Power Consumption (typ. 0.55 mA Supply Current in receive mode, no signal)
- Power Shutdown Mode (< 5 μA Shutdown Current in Full Temperature Range, up to 85 °C)
- Surface Mount Package, low profile (1.9 mm)
 Universal (L 6.0 mm x W 3.1 mm x H 1.9 mm)
- Directly Interfaces with Various Super I/O and Controller Devices
- Tri-state-Receiver Output, floating in shut down with a weak pull-up
- Split power supply, transmitter and receiver can be operated from two power supplies with relaxed requirements saving costs, US - Patent No. 6,157,476
- Only One External Component Required
- TV Remote Control supported

Applications

- Telecommunication Products (Cellular Phones, Pagers)
- · Digital Still and Video Cameras
- Printers, Fax Machines, Photocopiers, Screen Projectors
- Medical and Industrial Data Collection
- Notebook Computers, Desktop PCs, Palmtop Computers (Win CE, Palm PC), PDAs
- Internet TV Boxes, Video Conferencing Systems
- External Infrared Adapters (Dongles)
- Kiosks, POS, Point and Pay Devices including IrFM - Applications

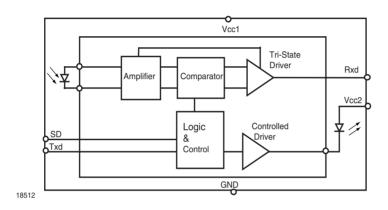
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Parts Table

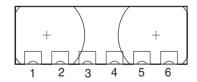
Part	Part Description	
TFBS5711-TR1	Oriented in carrier tape for side view surface mounting	1000 pcs
TFBS5711-TR3	Oriented in carrier tape for side view surface mounting	2500 pcs

Functional Block Diagram



Pinout

TFBS5711 weight 50 mg



18466

Definitions:

In the Vishay transceiver data sheets the following nomenclature is used for defining the IrDA operating modes:

SIR: 2.4 kbit/s to 115.2 kbit/s, equivalent to the basic serial infrared standard with the physical layer version IrPhy 1.0

MIR: 576 kbit/s to 1152 kbit/s

FIR: 4 Mbit/s VFIR: 16 Mbit/s

MIR and FIR were implemented with IrPhy 1.1, followed by IrPhy 1.2, adding the SIR Low Power Standard. IrPhy 1.3 extended the Low Power Option to MIR and FIR and VFIR was added with IrPhy 1.4.A new version of the standard in any case obsoletes the former version.

With introducing the updated versions the old versions are obsolete. Therefore the only valid IrDA standard is the actual version IrPhy 1.4 (in Oct. 2002).



Pin Description

Pin Number	Function	Description	I/O	Active
1	V _{CC2} IRED Anode	Connect IRED anode directly to be the power supply (V _{CC2}). An external resistor is necessary for controlling the IRED current. A separate unregulated power supply can be used at this pin.		
2	Txd	This Schmitt-Trigger input is used to transmit serial data when SD is low. An on-chip protection circuit disables the LED driver if the Txd pin is asserted for longer than 80 μs. When used in conjunction with the SD pin, this pin is also used to control receiver output pulse duration.	I	HIGH
3	Rxd	Received Data Output, push-pull CMOS driver output capable of driving standard CMOS or TTL loads. No external pull-up or pull-down resistor is required. Floating with a weak pull-up of 500 k Ω (typ.) in shutdown mode.	0	LOW
4	SD	Shutdown, also used for setting the output pulse duration. Setting this pin active for more than 1.5 ms places the module into shutdown mode. Before that (t < 0.7 ms) on the falling edge of this signal, the state of the Txd pin is sampled and used to set the receiver output to long pulse duration (2 µs) or to short pulse duration (0.4 µs) mode	I	HIGH
5	V _{CC1}	Supply Voltage		
6	GND	Ground		

Absolute Maximum Ratings

Reference point Ground (Pin 6) unless otherwise noted.

Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

* '	,	•	ŭ			
Parameter	Test Conditions	Symbol	Min	Тур.	Max	Unit
Supply voltage range, transceiver	- 0.3 V < V _{CC2} < 6 V	V _{CC1}	- 0.3		+ 6.0	V
Supply voltage range, transmitter	- 0.5 V < V _{CC1} < 6 V	V _{CC2}	- 0.3		+ 6.5	V
Input currents	for all pins, except IRED anode pin				10	mA
Output sinking current					25	mA
Power dissipation	see derating curve	P_{D}			500	mW
Junction temperature		T_J			125	°C
Ambient temperature range (operating)		T _{amb}	- 25		+ 85	°C
Storage temperature range		T _{stg}	- 25		+ 85	°C
Soldering temperature	see recommended solder profile				240	°C
Average output current, pin 1		I _{IRED(DC)}			125	mA
Repetitive pulsed output current, pin 1	t < 90 μs, t _{on} < 20 %	I _{IRED(RP)}			600	mA
IRED anode voltage, pin 1		V _{IREDA}	- 0.5		+ 6.5	V
Voltage at all inputs and outputs	V _{in} < V _{CC1} is allowed	V _{in}	- 0.5		+ 5.5	V
Load at mode pin when used as mode indicator					50	pF

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Eye safety information

Parameter	Test Conditions	Symbol	Min	Тур.	Max	Unit
Virtual source size	Method: (1-1/e) encircled energy	d	1.3	1.5		mm
Maximum intensity for class 1	IEC60825-1 or EN60825-1, edition Jan. 2001, operating below the absolute maximum ratings	I _e			*) (500) ^{**)}	mW/sr

^{*)} Due to the internal limitation measures the device is a "class 1" device.

Electrical Characteristics

Transceiver

 T_{amb} = 25 °C, V_{CC1} = V_{CC2} = 2.7 V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

Parameter	Test Conditions	Symbol	Min	Тур.	Max	Unit
Supply voltage		V _{CC1}	2.7		5.5	V
Dynamic supply current	SD = Low, E _e = 1 klx	I _{CC}		550	900	μΑ
Average dynamic supply current, transmitting	I _{IRED} = 500 mA, 25 % Duty Cycle	I _{CC}		1100	1500	μΑ
Standby supply current	$SD = High, T = 25 ^{\circ}C, E_e = 0 klx$	I _{SD}			1	μΑ
	SD = High, T = 25 °C, E _e = 1 klx*)	I _{SD}			2.5	μΑ
	SD = High, T = 85 °C, not ambient light sensitive	I _{SD}			5	μΑ
Operating temperature range		T _A	- 25		+ 85	°C
Output voltage low, Rxd	C_{Load} = 15 pF, I_{OL} = 1 mA	V _{OL}			0.4	V
Output voltage high, Rxd	I _{OH} = - 500 μA	V _{OH}	0.8 x V _{CC1}			V
	$I_{OH} = -250 \mu A, C_{Load} = 15 pF$	V _{OH}	0.9 x V _{CC1}			V
Rxd to V _{CC1} impedance		R _{Rxd}	400	500	600	kΩ
Input voltage low (Txd, SD)		V _{IL}	- 0.5		0.5	V
Input voltage high (Txd, SD)	CMOS level**)	V _{IH}	V _{CC1} - 0.5		V _{CC1} + 0.5	V
Input leakage current (Txd, SD)	$V_{in} = 0.9 \times V_{CC1}$	I _{ICH}	- 2		+ 2	μΑ
Controlled pull down current	SD, Txd = "0" to "1", 0 < V _{in} < 0.15 V _{CC1}	I _{IRTx}			+ 150	μΑ
	SD, Txd = "0" to "1", V _{in} > 0.7 V _{CC1}	I _{IRTx}	- 1	0	1	μΑ
Input capacitance (Txd, SD)		C _{IN}			5	pF

^{*)} Standard illuminant A

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^{**)} IrDA specifies the max. intensity with 500 mW/sr.

^{**)} The typical threshold level is 0.5 x V_{CC1}. It is recommended to use the specified min/max values to avoid increased operating current.



Optoelectronic Characteristics

Receiver

 T_{amb} = 25 °C, V_{CC1} = V_{CC2} = 2.7 V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

Parameter	Test Conditions	Symbol	Min	Тур.	Max	Unit
Minimum detection threshold irradiance	9.6 kbit/s to 1152 kbit/s λ = 850 nm - 900 nm	E _e		100 (10)	150 (15)	mW/m ² (μW/cm ²⁾
Maximum detection threshold irradiance	λ = 850 nm - 900 nm	E _e		5 (500)		kW/m ² (mW/cm ²)
Logic LOW receiver input irradiance		E _e	4 (0.4)			mW/m ² (μW/cm ²⁾
Rise time of output signal	10 % to 90 %, C _L = 15 pF	t _{r(Rxd)}	20		60	ns
Fall time of output signal	90 % to 10 %, C _L = 15 pF	t _{f(Rxd)}	20		60	ns
Rxd pulse width of output signal, default mode after power on	input pulse length t _{PWopt} > 200 ns	t _{PW}	300	400	500	ns
SIR ENDEC compatibility mode*): Rxd pulse width of output signal	input pulse length t _{PWopt} > 200 ns, see chapter "Programming"	t _{PW}	1.7	2.0	2.9	μs
Stochastic jitter, leading edge	input irradiance = 100 mW/m ² , 1.152 Mbit/s, 576 kbit/s				80	ns
	input irradiance = 100 mW/m ² , ≤ 115.2 kbit/s				350	ns
Standby /Shutdown delay	after shutdown active or (SD low to high transition)		0.6		1.5	ms
Shutdown active time window for programming	During this time the pulse duration of the output can be programmed to the application mode. see chapter "Programming"				600	μѕ
Receiver start up time power on delay shutdown recovery delay	after shutdown inactive (SD high to low transition) and after power-on				300	μs
Latency		t _L			200	μs

^{*)} Some ENDECs are not able to decode short pulses as valid SIR pulses. Therefore this additional mode was added in TFDU5307. TFDU5307 is set to the "short output pulse" as default after power on, also after recovering from the shutdown mode (SD must have been longer active than 1.5 ms). For mode changing see the chapter "Programming"

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TFBS5711

Vishay Semiconductors



Transmitter

 T_{amb} = 25 °C, V_{CC1} = V_{CC2} = 2.7 V to 5.5 V unless otherwise noted. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.

Parameter	Test Conditions	Symbol	Min	Тур.	Max	Unit
IRED operating current, recommended serial resistor for MIR applications	$V_{CC2} = 3.3 \text{ V: } R_S = 2.0 \Omega$ $V_{CC2} = 5.0 \text{ V: } R_S = 5.6 \Omega$	I _D		400	500	mA
Output leakage IRED current	$Txd = 0 V, 0 < V_{CC1} < 5.5 V$	I _{IRED}	- 1		1	μΑ
Output radiant intensity recommended application circuit, see figure 1	$I_F = 250 \text{ mA}, \ \alpha = 0 \text{ °}, \ \alpha = 15 \text{ °}, \ V_{CC2} = 2.7 \text{ V}, \ Txd = High, \ SD = Low$	I _e	10	25		mW/sr
Output radiant intensity	$V_{CC1} = 5.0 \text{ V}, \alpha = 0 ^{\circ}, 15 ^{\circ}$ Txd = Low or SD = High (Receiver is inactive as long as SD = High)	l _e			0.04	mW/sr
Output radiant intensity, angle of half intensity		α		± 24		0
Peak - emission wavelength*)		λ_{p}	880		900	nm
Spectral bandwidth		Δλ		45		nm
Optical rise time, fall time		t _{ropt} , t _{fopt}	10		40	ns
Optical output pulse duration	input pulse width 217 ns, 1.152 Mbit/s	t _{opt}	200	217	240	ns
	input pulse width t _{Txd} < 80 μs	t _{opt}	20		t _{Txd}	μs
	input pulse width $t_{Txd} \ge 80 \mu s$	t _{opt}	20		85	μs
Optical overshoot					25	%

^{*)} Note: Due to this wavelength restriction compared to the IrDA spec of 850 nm to 900 nm the transmitter is able to operate as source for the standard Remote Control applications with codes as e.g. Phillips RC5/RC6[®] or RECS 80. With the typical specified intensity an RC operating range of about 4 m can be expected.

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Recommended Circuit Diagram for IrDA® and Remote Control Operation

In general Vishay transceivers are using the identical circuit for IrDA and Remote Control operation. For using the IrDA transceiver as an RC transmitter no change of the operating circuit is necessary. Used with a clean low impedance power supply the TFBS5711 only needs an external series current limiting resistor. However, depending on the entire system design and board layout, additional external components may be required (see figure 1).

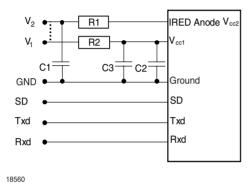


Figure 1. Recommended Application Circuit

The capacitor C1 is buffering the supply voltage and eliminates the inductance of the power supply line. This one should be a Tantalum or other fast capacitor to guarantee the fast rise time of the IRED current. The resistor R1 is the current limiting resistor and this is supply voltage dependent, see derating curve in figure 4, to avoid too high internal power dissipation. Vishay's transceivers integrate a sensitive receiver and a built-in power driver. The combination of both needs a careful circuit board layout. The use of thin, long, resistive and inductive wiring should be avoided. The inputs (Txd, SD) and the output Rxd should be directly (DC) coupled to the I/O circuit.

The capacitor C2 combined with the resistor R2 is the low pass filter for smoothing the supply voltage.

R2, C1 and C2 are optional and dependent on the quality of the supply voltages V₁ and V₂ and injected noise. An unstable power supply with dropping voltage during transmission may reduce the sensitivity (and transmission range) of the transceiver.

The placement of these parts is critical. It is strongly recommended to position C2 as close as possible to the transceiver power supply pins. An Tantalum capacitor should be used for C1 while a ceramic capacitor is used for C2.

In addition, when connecting the described circuit to the power supply, low impedance wiring should be used.

When extended wiring is used the inductance of the power supply can cause dynamically a voltage drop at V₂. Often some power supplies are not apply to follow the fast current rise time. In that case another 4.7 μ F (type, see table under C1) at V_2 will be helpful.

Under extreme EMI conditions as placing an RFtransmitter antenna on top of the transceiver, we recommend to protect all inputs by a low-pass filter, as a minimum a 12 pF capacitor, especially at the Rxd

Keep in mind that basic RF - design rules for circuit design should be taken into account. Especially longer signal lines should not be used without termination. See e.g. "The Art of Electronics" Paul Horowitz, Winfield Hill, 1989, Cambridge University Press, ISBN: 0521370957.

Table 1. **Recommended Application Circuit Components**

Component	Recommended Value	Vishay Part Number
C1	4.7 μF, 16 V	293D 475X9 016B
C2	0.1 μF, Ceramic	VJ 1206 Y 104 J XXMT
R1	5 V supply voltage: 5.6Ω s. text $0.25 W$ (recommended using two 2.8Ω , $0.125 W$ resistors in series). 3.3 V supply voltage: 2.0Ω s. text $0.25 W$	e.g. 2 x CRCW-1206-2R0-F-RT1 for 3.3 V supply voltage
R2	47 Ω, 0.125 W	CRCW-1206-47R0-F-RT1

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I/O and Software

In the description, already different I/Os are mentioned. Different combinations are tested and the function verified with the special drivers available from the I/O suppliers. In special cases refer to the I/O manual, the Vishay application notes, or contact directly Vishay Sales, Marketing or Application.

Programming Pulse duration Switching

After Power-on the TFBS5711 is in the default short Rxd pulse duration mode.

Some ENDECs are not able to decode short pulses as valid SIR pulses. Therefore an additional mode with extended pulse duration (same as in standard SIR transceivers) is added in TFBS5711. TFBS5711 is set to the "short output pulse" as default after power on, and after recovering from the shutdown mode (SD being active longer than 1.5 ms).

To switch the transceivers from the short Rxd pulse duration mode to the long pulse duration mode and vice versa, follow the procedure described below.

Setting to the ENDEC compatibility mode with an Rxd pulse duration of 2 μ s

- 1. Set SD input to logic "HIGH".
- 2. Set Txd input to logic "HIGH". Wait $t_s \ge 200$ ns.
- 3. Set SD to logic "LOW" (this negative edge latches state of Txd, which determines speed setting).
- 4. After waiting $t_h \ge 200$ ns.

After that Txd is enabled as normal Txd input and the Rxd output is set for the longer Rxd - pulse duration mode.

Setting back to the default mode with a 400 ns pulse duration

- 1. Set SD input to logic "HIGH".
- 2. Set Txd input to logic "LOW". Wait $t_s \ge 200$ ns.
- 3. Set SD to logic "LOW" (this negative edge latches state of Txd, which determines speed setting).



4. After waiting $t_h \geq 200$ ns Txd can be set to logic "LOW". The hold time of Txd is limited by the maximum allowed pulse length.

After that Txd is now enabled as normal Txd input and the Rxd output is set for the short Rxd - pulse duration mode.

The timing of the pulse duration changing procedure is quite uncritical. However, the whole change must not take more than $600~\mu s$. See in the spec. "Shutdown Active Time Window for Programming"

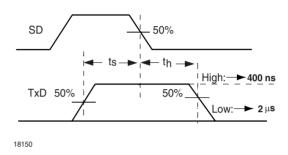


Figure 2. Timing Diagram for changing the output pulse duration

Simplified Method

Setting the device to the long pulse duration is simply applying a short active (less than $600~\mu s$) pulse to SD (Txd = Low). In any case a short SD pulse will force the device to leave the default mode and go the compatibility mode. Vice versa applying a 1.5 ms (minimum) pulse at SD will cause the device to go back to the default mode by activating a power-on-reset and setting the device to the default short pulse mode. This simplified method takes more time but may be easier to handle.

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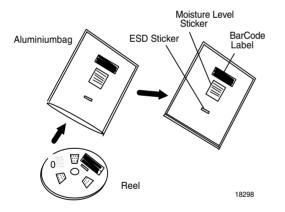


Table 2.
Truth table

		Inputs	Out	puts	Remark
SD	Txd	Optical input Irradiance mW/m ²	Rxd	Transmitter	Operation
high < 600 μs	Х	х	weakly pulled (500 k Ω) to V _{CC1}	0	Time window for pulse duration setting
high > 1.5 ms	х	х	weakly pulled (500 k Ω) to V _{CC1}	0	Shutdown
low	high	х	high inactive	I _e	Transmitting
low	high > 80 μs	х	high inactive	0	Protection is active
low	low	< 4	high inactive	0	Ignoring low signals below the IrDA defined threshold for noise immunity
low	low	> Min. Detection Threshold Irradiance < Max. Detection Threshold Irradiance	low (active)	0	Response to an IrDA compliant optical input signal
low	low	> Max. Detection Threshold Irradiance	undefined	0	Overload conditions can cause unexpected outputs

Dry packing

The reel is packed in a moisture proof aluminum bag to protect the device from absorbing moisture during transportation and storage.



Recommended Method of Storage

Dry box storage is recommended as soon as the dry bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:



Acc. to JEDEC Standard JESD22-A113

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Recommended Solder Profile

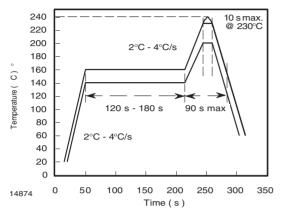


Figure 3. Recommended Solder Profile

Current Derating Diagram

Figure 4 shows the maximum operating temperature when the device is operated without external current limiting resistor. A minimum resistor of 2 Ohms is recommended from the anode of the IRED to V_{CC} .

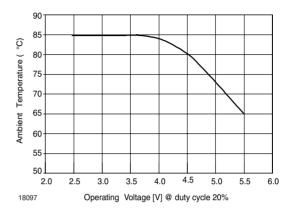
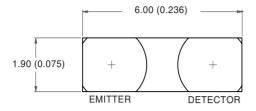


Figure 4. Temperature Derating Diagram

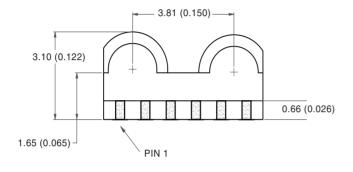
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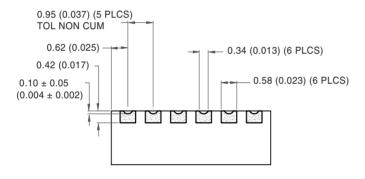
Package Dimensions in mm (Inches)

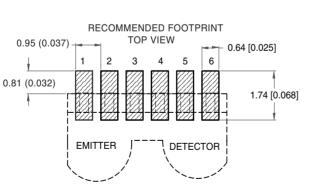








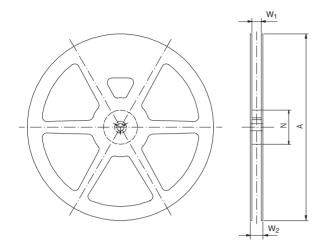


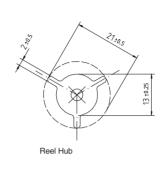


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Reel Dimensions





14017

Tape Width	A max.	N	W ₁ min.	W ₂ max.	W_3 min.	W ₃ max.
mm	mm	mm	mm	mm	mm	mm
16	330	50	16.4	22.4	15.9	19.4

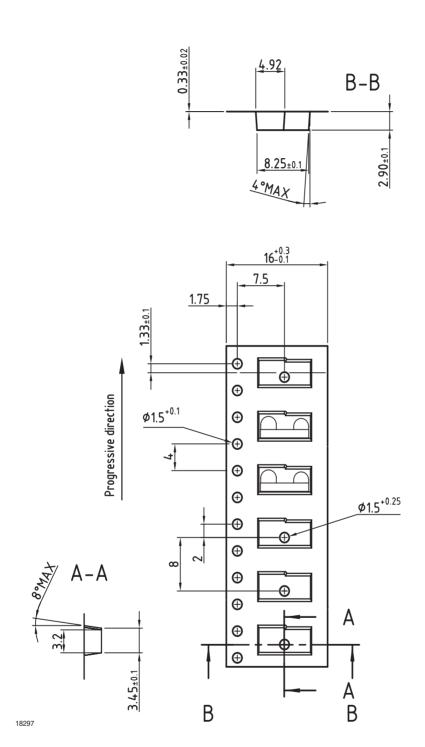
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Tape Dimensions in mm



TFBS5711

Vishay Semiconductors



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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